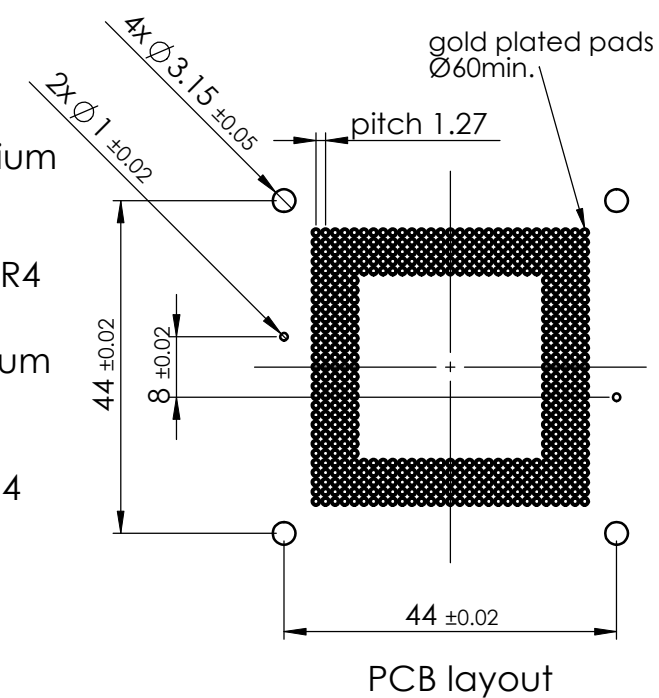
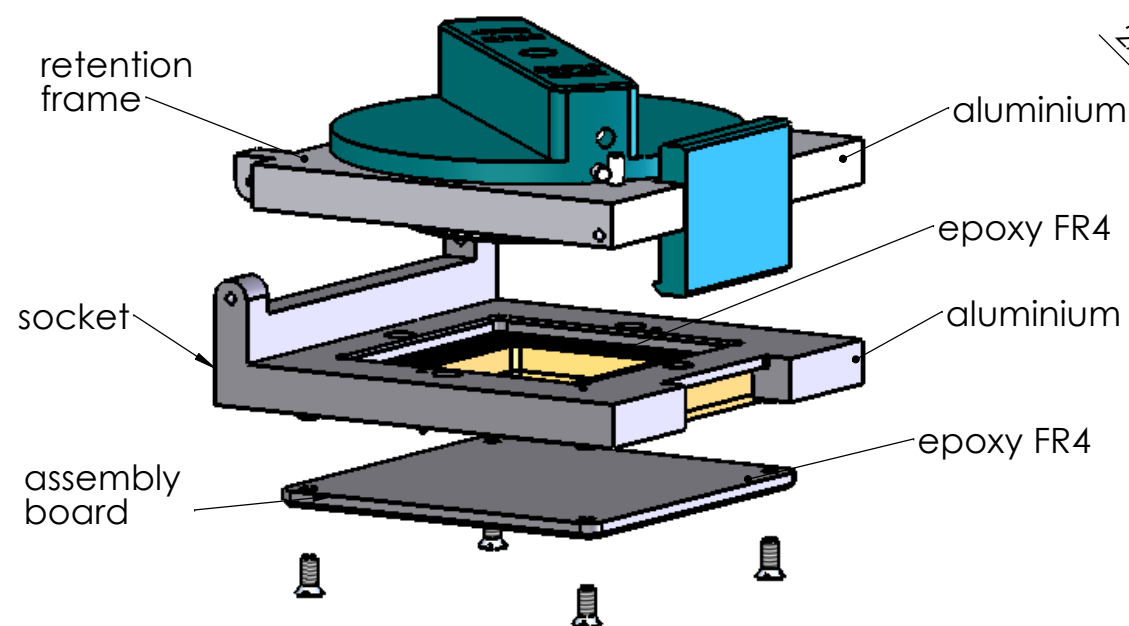
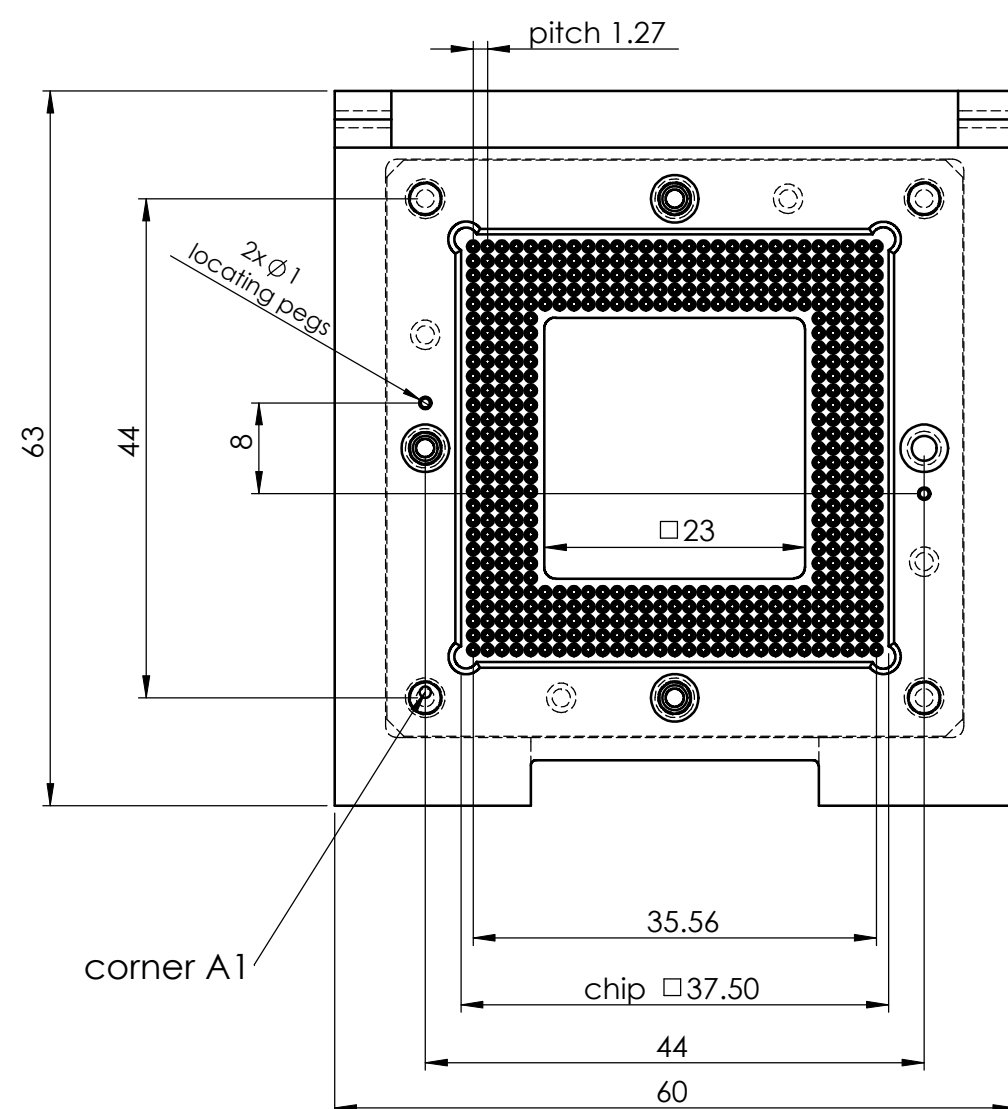




Assembly board



UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN MILLIMETERS SURFACE FINISH: GENERAL TOLERANCES: ± 0.10 LINEAR: ANGULAR:		Remark:		BGA Clamshell socket,480pins, pitch 1.27mm, matrix 29x29 basic system 60x63		 E-tec Interconnect					
"top view drawing"		Patented		Visa	Date	Drawn by	Date	Visa	www.e-tec.com		
DRAWN		sme	28.08.08	sme	09.06.08			TITLE:			
CHK'D				Echelle: 1.5:1		MATERIAL:		DWG NO.		BCC0480-12-09282-29AAA-L	A3H
APPV'D		K.S	28.08.08								
				WEIGHT:				SHEET 1 OF 1		1	Revision
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